

Products Documentation Resources My Account Customer Support

Home > Products > Removable Memory Products > Product Feature Selector > Product Details

5120615-1 Product Details

Have a Ouestion?

Chat with a Product Information Specialist

Quick Links

Check Pricing & Availability
 Search for Tooling

Search for Tooling Product Feature Selector

Contact Us About This Product





Removable Memory Products

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- 50 Positions
 Format = CompactFlash™
 CompactFlash™ Product Type = Header Only
 Header Type = Type I
 Lead Type = Surface Mount Staggered leads

View all Features

TE Internal Number: 5120615-1 ✓ Active







Related Products:

🔁 <u>View 3D PDF</u>

Documentation & Additional Information

PIN HEADER ASSEMBLY, 50 POSN, SMT, TOP MOUNT, LOW PR... (PDF, English)

Catalog Pages/Data Sheets:

Product Specifications:

COMPACT FLASH CARD, 1.27mm(.050") PITCH (PDF, English)

Application Specifications:

Instruction Sheets:

CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version O)
 3D Model (IGES, Version O)
- 3D Model (STEP, Version O)

List all Documents

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Profile = Low
- Holddowns = Without
- Color = Black
- Comment = Two size M2 screws (customer supplied) are required for fastening the connector to the PC board.

Mechanical Attachment:

Mounting Style = Top (Printed Circuit Board)

Electrical Characteristics:

Shielded = No

Termination Related Features:

Body Related Features:

- Number of Positions = 50
- CompactFlash™ Product Type = Header Only
- Header Type = Type I
- Lead Type = Surface Mount Staggered leads
- PCB Offset (mm [in]) = 0.00 [0.000]
- Number of Rows = Dual
- Centerline (mm [in]) = 1.27 [0.050]

- Contact Related Features:
 Contact Plating, Mating Area, Material = Gold (30)
 - Vacuum Tape = Without
 - Region = Americas
 - Contact Base Material = Beryllium Copper
 - Contact Underplating = Nickel

- Housing Related Features:

 Housing Material = Liquid Crystal Polymer (LCP)
 - UL Flammability Rating = UL 94V-0

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- · RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:

Format = CompactFlash™

Packaging Related Features:

Packaging Method = 72mm Tape & Reel

Other:
• Brand = AMP



Quick Links Corporate Information

Who We Are Check Distributor Inventory Investors Cross Reference

News Room Find Documents & Drawings Supplier Portal Product Compliance Support Center

Site Map Careers

Customer Support

Email or Chat with Us Find a Phone Number

Search Knowledge Base Manage Your Account

Sign up for our eNewsletter

Enter your email address





Provide Website Feedback

© 2010 Tyco Electronics All Rights Reserved | Privacy Policy

Downloaded from Elcodis.com electronic components distributor